Application Number:	10710399						
Filing Date:	08-Jul-2004						
Title of Invention:		SEMICONDUCTOR PACKAGE AND METHOD FOR MANUFACTURING THE SAME					
First Named Inventor:	Min-Jer Lin						
Filer:	Winston Hsu						
Attorney Docket Number:	LKSP0027USA						
Filed as Large Entity							
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:			1				
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 1 month with \$0 paid		1251	1	120	120		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			120